



# BC847CDLP

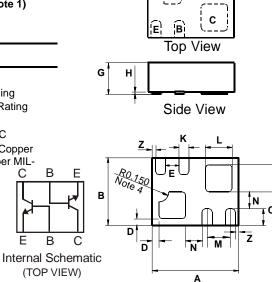
NPN DUAL SURFACE MOUNT TRANSISTOR

#### Features

- **Epitaxial Planar Die Construction** .
- Ideally Suited for Automated Assembly Processes
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- **Ultra Low Profile Package**

#### Mechanical Data

- Case: DFN1310H4-6
- Case Material: Molded Plastic, "Green" Molding • Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish --- NiPdAu annealed over Copper leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 С
- Marking Code Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.0015g (approximate)



в ¦Ε

DFN1310H4-6				
Dim	Min	Max	Тур	
Α	1.25	1.38	1.30	
в	0.95	1.08	1.00	
С	0.20	0.30	0.25	
D*	-	-	0.10	
E**	-	-	0.20	
G	-	0.40	-	
н	0	0.05	0.02	
K*	0.10	0.20	0.15	
L*	0.30	0.50	0.40	
M**	-	-	0.35	
<b>N</b> *	-	-	0.25	
Z**	-	-	0.05	
All Dimensions in mm				

**Bottom View** 

\* Dimensions D, K, L, N Repeat 4X \*\* Dimensions E, M, Z Repeat 2X

#### **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

			1
Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	50	V
Collector-Emitter Voltage	V <sub>CEO</sub>	45	V
Emitter-Base Voltage	V <sub>EBO</sub>	6.0	V
Collector Current	Ι <sub>c</sub>	100	mA
Power Dissipation (Note 3)	Pd	350	mW
Thermal Resistance, Junction to Ambient (Note 3)	R <sub>θJA</sub>	357	°C/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-65 to +150	°C

Notes:

1. No purposefully added lead.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.

В

В

E

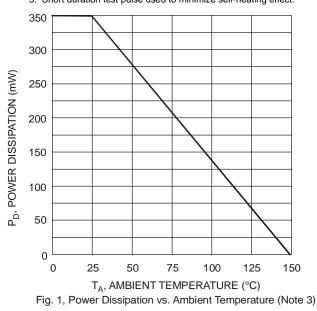
 Device mounted on FR-4 PCB pad layout as shown on page 4.
Radiused pad feature is intended for device manufacturing control and should not be considered as a polarity indicator, or to suggest orientation of the devices in the carrier tape.

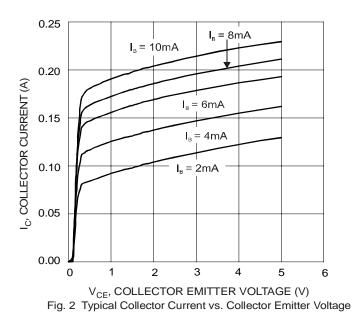


# **Electrical Characteristics** $@T_A = 25^{\circ}C$ unless otherwise specified

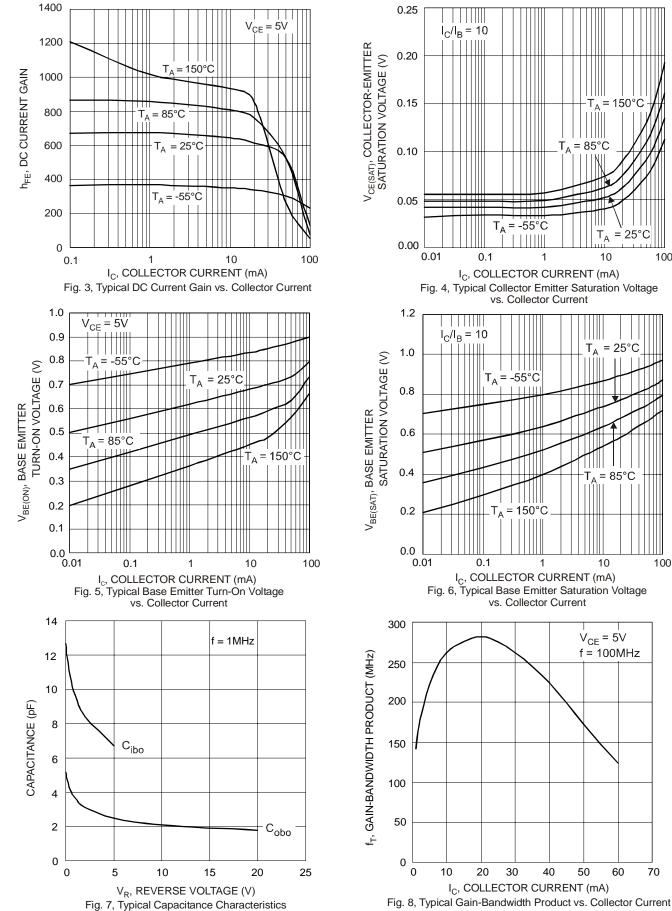
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage (Note 5)	V <sub>(BR)CBO</sub>	50		-	V	$I_{\rm C} = 10 \mu A, I_{\rm B} = 0$
Collector-Emitter Breakdown Voltage (Note 5)	V <sub>(BR)CEO</sub>	45		_	V	$I_{\rm C} = 10 {\rm mA}, \ I_{\rm B} = 0$
Emitter-Base Breakdown Voltage (Note 5)	V <sub>(BR)EBO</sub>	6		_	V	$I_{E} = 1 \mu A, I_{C} = 0$
DC Current Gain (Note 5)	h <sub>FE</sub>	420	650	800	_	$V_{CE} = 5.0V, I_C = 2.0mA$
Collector-Emitter Saturation Voltage (Note 5)	V <sub>CE(SAT)</sub>	_	55 130	250 600	mV	$I_{C} = 10mA$ , $I_{B} = 0.5mA$ $I_{C} = 100mA$ , $I_{B} = 5.0mA$
Base-Emitter Saturation Voltage (Note 5)	V <sub>BE(SAT)</sub>		700 900	_	mV	$I_{C} = 10mA$ , $I_{B} = 0.5mA$ $I_{C} = 100mA$ , $I_{B} = 5.0mA$
Base-Emitter Voltage (Note 5)	$V_{\text{BE(ON)}}$	580 —	660 —	700 770	mV	$V_{CE} = 5.0V, I_{C} = 2.0mA$ $V_{CE} = 5.0V, I_{C} = 10mA$
Collector-Cutoff Current (Note 5)	I <sub>CES</sub> I <sub>CBO</sub> I <sub>CBO</sub>			15 15 5.0	nA nA μA	$V_{CE} = 50V$ $V_{CB} = 30V$ $V_{CE} = 30V, T_A = 150^{\circ}C$
Gain Bandwidth Product	f <sub>T</sub>	100	_		MHz	$V_{CE} = 5.0V, I_{C} = 10mA,$ f = 100MHz
Collector-Base Capacitance		_	2.0	_	pF	V <sub>CB</sub> = 10V, f = 1MHz

Notes: 3. Device mounted on FR-5 PCB pad layout as shown on page 4.5. Short duration test pulse used to minimize self-heating effect.









NEW PRODUCT

70

Τ<sub>A</sub>

85°C

 $\mathsf{T}_\mathsf{A}$ = 25 °C

10

 $T_A$ 

= 25°C

85 °C

10

 $V_{CE} = 5V$ 

50

40

60

f = 100MHz

100

100

1

= 150°C



#### Ordering Information (Note 6)

Device	Package	Shipping
BC847CDLP-7	DFN1310H4-6	3000/Tape & Reel

Notes: 6. For packaging details, please go to our website at http://www.diodes.com/ap02007.pdf.

### Marking Information (Note 7)

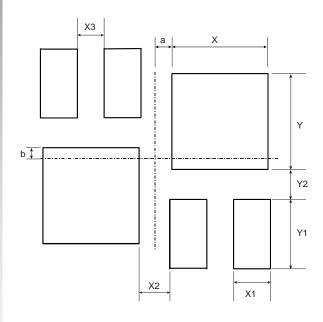


1M = Product Type Marking Code

(TOP VIEW)

Note: 7. Package is non-polarized. Parts may be on reel in orientation illustrated, 180° rotated or mixed (both ways).

## Suggested Pad Layout



DFN1310H4-6		
Dim	Value	
Х	0.52	
Y	0.52	
X1	0.20	
Y1	0.375	
X2	0.17	
Y2	0.16	
X3	0.15	
а	0.09	
b	0.06	
All Dimensions in mm		

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